NXP USA Inc. - MCHC908QY1CDWE Datasheet

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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	HC08
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	LVD, POR, PWM
Number of I/O	13
Program Memory Size	1.5KB (1.5K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-SOIC (0.295", 7.50mm Width)
Supplier Device Package	16-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/mchc908qy1cdwe

Chapter 7
Central Processor Unit (CPU)

Chapter 8
External Interrupt (IRQ)

Chapter 9
Keyboard Interrupt Module (KBI)

- On-chip in-application programmable FLASH memory (with internal program/erase voltage generation)
  - MC68HC908QY4 and MC68HC908QT4 — 4096 bytes
  - MC68HC908QY2, MC68HC908QY1, MC68HC908QT2, and MC68HC908QT1 — 1536 bytes
- 128 bytes of on-chip random-access memory (RAM)
- 2-channel, 16-bit timer interface module (TIM)
- 4-channel, 8-bit analog-to-digital converter (ADC) on MC68HC908QY2, MC68HC908QY4, MC68HC908QT2, and MC68HC908QT4
- 5 or 13 bidirectional input/output (I/O) lines and one input only:
  - Six shared with keyboard interrupt function and ADC
  - Two shared with timer channels
  - One shared with external interrupt (IRQ)
  - Eight extra I/O lines on 16-pin package only
  - High current sink/source capability on all port pins
  - Selectable pullups on all ports, selectable on an individual bit basis
  - Three-state ability on all port pins
- 6-bit keyboard interrupt with wakeup feature (KBI)
- Low-voltage inhibit (LVI) module features:
  - Software selectable trip point in CONFIG register
- System protection features:
  - Computer operating properly (COP) watchdog
  - Low-voltage detection with reset
  - Illegal opcode detection with reset
  - Illegal address detection with reset
- External asynchronous interrupt pin with internal pullup ($\overline{\text{IRQ}}$) shared with general-purpose input pin
- Master asynchronous reset pin ($\overline{\text{RST}}$) shared with general-purpose input/output (I/O) pin
- Power-on reset
- Internal pullups on $\overline{\text{IRQ}}$ and $\overline{\text{RST}}$ to reduce external components
- Memory mapped I/O registers
- Power saving stop and wait modes
- MC68HC908QY4, MC68HC908QY2, and MC68HC908QY1 are available in these packages:
  - 16-pin plastic dual in-line package (PDIP)
  - 16-pin small outline integrated circuit (SOIC) package
  - 16-pin thin shrink small outline package (TSSOP)
- MC68HC908QT4, MC68HC908QT2, and MC68HC908QT1 are available in these packages:
  - 8-pin PDIP
  - 8-pin SOIC
  - 8-pin dual flat no lead (DFN) package

1.6 Pin Function Priority

Table 1-3 is meant to resolve the priority if multiple functions are enabled on a single pin.

NOTE

Upon reset all pins come up as input ports regardless of the priority table.

Table 1-3. Function Priority in Shared Pins

Pin Name	Highest-to-Lowest Priority Sequence
PTA0	AD0 → TCH0 → KBI0 → PTA0
PTA1	AD1 →TCH1 → KBI1 → PTA1
PTA2	$\overline{\text{IRQ}}$ → KBI2 → TCLK → PTA2
PTA3	$\overline{\text{RST}}$ → KBI3 → PTA3
PTA4	OSC2 → AD2 → KBI4 → PTA4
PTA5	OSC1 → AD3 → KBI5 → PTA5

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
$0006 ↓ $000A	Unimplemented									
	Unimplemented									
$000B	Port A Input Pullup Enable Register (PTAPUE) See page 99.	Read:	OSC2EN	0	PTAPUE5	PTAPUE4	PTAPUE3	PTAPUE2	PTAPUE1	PTAPUE0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
$000C	Port B Input Pullup Enable Register (PTBPUE) See page 102.	Read:	PTBPUE7	PTBPUE6	PTBPUE5	PTBPUE4	PTBPUE3	PTBPUE2	PTBPUE1	PTBPUE0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
$000D ↓ $0019	Unimplemented									
$001A	Keyboard Status and Control Register (KBSCR) See page 83.	Read:	0	0	0	0	KEYF	0	IMASKK	MODEK
		Write:						ACKK		
		Reset:	0	0	0	0	0	0	0	0
$001B	Keyboard Interrupt Enable Register (KBIER) See page 84.	Read:	0	AWUIE	KBIE5	KBIE4	KBIE3	KBIE2	KBIE1	KBIE0
		Write:								
		Reset:	0	0	0	0	0	0	0	0
$001C	Unimplemented									
$001D	IRQ Status and Control Register (INTSCR) See page 77.	Read:	0	0	0	0	IRQF	0	IMASK	MODE
		Write:						ACK		
		Reset:	0	0	0	0	0	0	0	0
$001E	Configuration Register 2 (CONFIG2)[1] See page 53.	Read:	IRQPUD	IRQEN	R	OSCOPT1	OSCOPT0	R	R	RSTEN
		Write:								
		Reset:	0	0	0	0	0	0	0	0[2]

1. One-time writable register after each reset.
2. RSTEN reset to 0 by a power-on reset (POR) only.

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
$001F	Configuration Register 1 (CONFIG1)[1] See page 54.	Read:	COPRS	LVISTOP	LVIRSTD	LVIPWRD	LVI5OR3	SSREC	STOP	COPD
		Write:								
		Reset:	0	0	0	0	0[2]	0	0	0

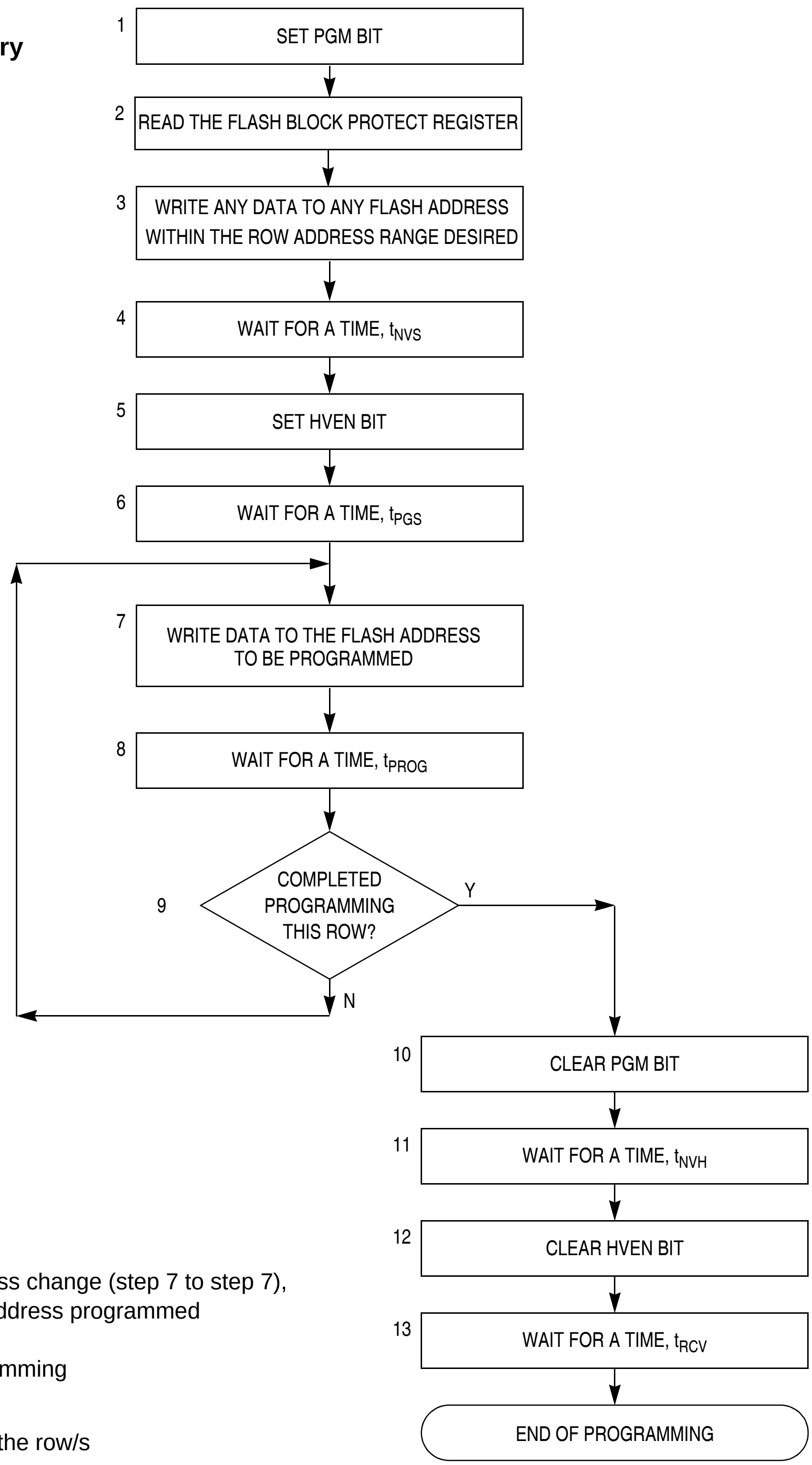
1. One-time writable register after each reset.
2. LVI5OR3 reset to 0 by a power-on reset (POR) only.

Addr.	Register Name		Bit 7	6	5	4	3	2	1	Bit 0
$0020	TIM Status and Control Register (TSC) See page 127.	Read:	TOF	TOIE	TSTOP	0	0	PS2	PS1	PS0
		Write:	0			TRST				
		Reset:	0	0	1	0	0	0	0	0
$0021	TIM Counter Register High (TCNTH) See page 128.	Read:	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
		Write:								
		Reset:	0	0	0	0	0	0	0	0

[shaded] = Unimplemented   R = Reserved   U = Unaffected

Figure 2-2. Control, Status, and Data Registers (Sheet 2 of 5)

Algorithm for Programming a Row (32 Bytes) of FLASH Memory



NOTES:

The time between each FLASH address change (step 7 to step 7), or the time between the last FLASH address programmed to clearing PGM bit (step 7 to step 10) must not exceed the maximum programming time, t_{PROG} max.

This row program algorithm assumes the row/s to be programmed are initially erased.

Figure 2-4. FLASH Programming Flowchart

IRQPUD — $\overline{IRQ}$ Pin Pullup Control Bit

1 = Internal pullup is disconnected
0 = Internal pullup is connected between $\overline{IRQ}$ pin and V_{DD}

IRQEN — $\overline{IRQ}$ Pin Function Selection Bit

1 = Interrupt request function active in pin
0 = Interrupt request function inactive in pin

OSCOPT1 and OSCOPT0 — Selection Bits for Oscillator Option

(0, 0) Internal oscillator
(0, 1) External oscillator
(1, 0) External RC oscillator
(1, 1) External XTAL oscillator

RSTEN — $\overline{RST}$ Pin Function Selection

1 = Reset function active in pin
0 = Reset function inactive in pin

NOTE

The RSTEN bit is cleared by a power-on reset (POR) only. Other resets will leave this bit unaffected.

Address: $001F

	Bit 7	6	5	4	3	2	1	Bit 0
Read: Write:	COPRS	LVISTOP	LVIRSTD	LVIPWRD	LVI5OR3	SSREC	STOP	COPD
Reset:	0	0	0	0	U	0	0	0
POR:	0	0	0	0	0	0	0	0

U = Unaffected

Figure 5-2. Configuration Register 1 (CONFIG1)

COPRS (Out of STOP Mode) — COP Reset Period Selection Bit

1 = COP reset short cycle = 8176 × BUSCLKX4
0 = COP reset long cycle = 262,128 × BUSCLKX4

COPRS (In STOP Mode) — Auto Wakeup Period Selection Bit

1 = Auto wakeup short cycle = 512 × INTRCOSC
0 = Auto wakeup long cycle = 16,384 × INTRCOSC

LVISTOP — LVI Enable in Stop Mode Bit

When the LVIPWRD bit is clear, setting the LVISTOP bit enables the LVI to operate during stop mode. Reset clears LVISTOP.

1 = LVI enabled during stop mode
0 = LVI disabled during stop mode

LVIRSTD — LVI Reset Disable Bit

LVIRSTD disables the reset signal from the LVI module.

1 = LVI module resets disabled
0 = LVI module resets enabled

Chapter 7
Central Processor Unit (CPU)

7.1 Introduction

The M68HC08 CPU (central processor unit) is an enhanced and fully object-code-compatible version of the M68HC05 CPU. The *CPU08 Reference Manual* (document order number CPU08RM/AD) contains a description of the CPU instruction set, addressing modes, and architecture.

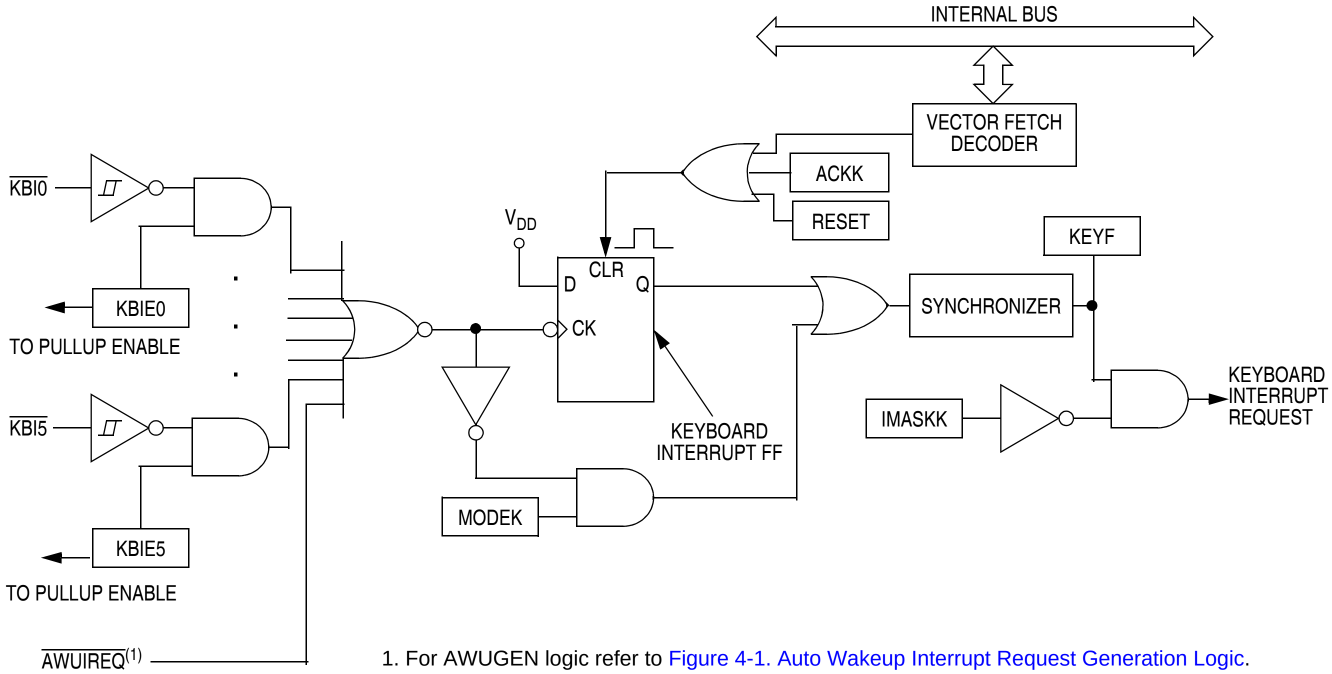
7.2 Features

Features of the CPU include:

- Object code fully upward-compatible with M68HC05 Family
- 16-bit stack pointer with stack manipulation instructions
- 16-bit index register with x-register manipulation instructions
- 8-MHz CPU internal bus frequency
- 64-Kbyte program/data memory space
- 16 addressing modes
- Memory-to-memory data moves without using accumulator
- Fast 8-bit by 8-bit multiply and 16-bit by 8-bit divide instructions
- Enhanced binary-coded decimal (BCD) data handling
- Modular architecture with expandable internal bus definition for extension of addressing range beyond 64 Kbytes
- Low-power stop and wait modes

7.3 CPU Registers

Figure 7-1 shows the five CPU registers. CPU registers are not part of the memory map.



1. For AWUGEN logic refer to Figure 4-1. Auto Wakeup Interrupt Request Generation Logic.

Figure 9-2. Keyboard Interrupt Block Diagram

If the MODEK bit is set, the keyboard interrupt inputs are both falling edge and low-level sensitive, and both of the following actions must occur to clear a keyboard interrupt request:

- Vector fetch or software clear — A vector fetch generates an interrupt acknowledge signal to clear the interrupt request. Software may generate the interrupt acknowledge signal by writing a 1 to the ACKK bit in the keyboard status and control register (KBSCR). The ACKK bit is useful in applications that poll the keyboard interrupt inputs and require software to clear the keyboard interrupt request. Writing to the ACKK bit prior to leaving an interrupt service routine can also prevent spurious interrupts due to noise. Setting ACKK does not affect subsequent transitions on the keyboard interrupt inputs. A falling edge that occurs after writing to the ACKK bit latches another interrupt request. If the keyboard interrupt mask bit, IMASKK, is clear, the central processor unit (CPU) loads the program counter with the vector address at locations $FFE0 and $FFE1.
- Return of all enabled keyboard interrupt inputs to logic 1 — As long as any enabled keyboard interrupt pin is at logic 0, the keyboard interrupt remains set. The auto wakeup interrupt input, AWUIREQ, will be cleared only by writing to ACKK bit in KBSCR or reset.

The vector fetch or software clear and the return of all enabled keyboard interrupt pins to logic 1 may occur in any order.

If the MODEK bit is clear, the keyboard interrupt pin is falling-edge sensitive only. With MODEK clear, a vector fetch or software clear immediately clears the keyboard interrupt request.

Reset clears the keyboard interrupt request and the MODEK bit, clearing the interrupt request even if a keyboard interrupt input stays at logic 0.

The keyboard flag bit (KEYF) in the keyboard status and control register can be used to see if a pending interrupt exists. The KEYF bit is not affected by the keyboard interrupt mask bit (IMASKK) which makes it useful in applications where polling is preferred.

V_{TRIPF}. Setting the LVI enable in stop mode bit, LVISTOP, enables the LVI to operate in stop mode. Setting the LVI 5-V or 3-V trip point bit, LVI5OR3, enables the trip point voltage, V_{TRIPF}, to be configured for 5-V operation. Clearing the LVI5OR3 bit enables the trip point voltage, V_{TRIPF}, to be configured for 3-V operation. The actual trip thresholds are specified in 16.5 5-V DC Electrical Characteristics and 16.9 3-V DC Electrical Characteristics.

NOTE

After a power-on reset, the LVI's default mode of operation is 3 volts. If a 5-V system is used, the user must set the LVI5OR3 bit to raise the trip point to 5-V operation.

If the user requires 5-V mode and sets the LVI5OR3 bit after power-on reset while the V_{DD} supply is not above the V_{TRIPR} for 5-V mode, the microcontroller unit (MCU) will immediately go into reset. The next time the LVI releases the reset, the supply will be above the V_{TRIPR} for 5-V mode.

Once an LVI reset occurs, the MCU remains in reset until V_{DD} rises above a voltage, V_{TRIPR}, which causes the MCU to exit reset. See Chapter 13 System Integration Module (SIM) for the reset recovery sequence.

The output of the comparator controls the state of the LVIOUT flag in the LVI status register (LVISR) and can be used for polling LVI operation when the LVI reset is disabled.

10.3.1 Polled LVI Operation

In applications that can operate at V_{DD} levels below the V_{TRIPF} level, software can monitor V_{DD} by polling the LVIOUT bit. In the configuration register, the LVIPWRD bit must be cleared to enable the LVI module, and the LVIRSTD bit must be at set to disable LVI resets.

10.3.2 Forced Reset Operation

In applications that require V_{DD} to remain above the V_{TRIPF} level, enabling LVI resets allows the LVI module to reset the MCU when V_{DD} falls below the V_{TRIPF} level. In the configuration register, the LVIPWRD and LVIRSTD bits must be cleared to enable the LVI module and to enable LVI resets.

10.3.3 Voltage Hysteresis Protection

Once the LVI has triggered (by having V_{DD} fall below V_{TRIPF}), the LVI will maintain a reset condition until V_{DD} rises above the rising trip point voltage, V_{TRIPR}. This prevents a condition in which the MCU is continually entering and exiting reset if V_{DD} is approximately equal to V_{TRIPF}. V_{TRIPR} is greater than V_{TRIPF} by the hysteresis voltage, V_{HYS}.

10.3.4 LVI Trip Selection

The LVI5OR3 bit in the configuration register selects whether the LVI is configured for 5-V or 3-V protection.

NOTE

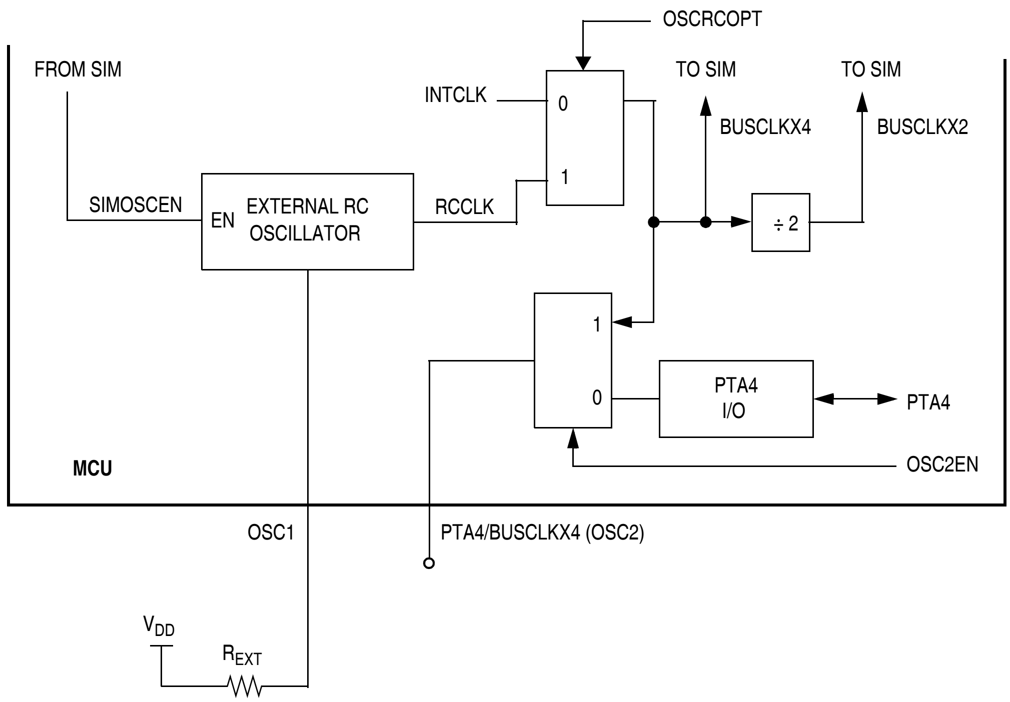
The microcontroller is guaranteed to operate at a minimum supply voltage. The trip point (V_{TRIPF} [5 V] or V_{TRIPF} [3 V]) may be lower than this. See 16.5 5-V DC Electrical Characteristics and 16.9 3-V DC Electrical Characteristics for the actual trip point voltages.

11.3.4 RC Oscillator

The RC oscillator circuit is designed for use with an external resistor (R_{EXT}) to provide a clock source with a tolerance within 25% of the expected frequency. See Figure 11-3.

The capacitor (C) for the RC oscillator is internal to the MCU. The R_{EXT} value must have a tolerance of 1% or less to minimize its effect on the frequency.

In this configuration, the OSC2 pin can be left in the reset state as PTA4. Or, the OSC2EN bit in the port A pullup enable register can be set to enable the OSC2 output function on the pin. Enabling the OSC2 output slightly increases the external RC oscillator frequency, f_{RCCLK}.



See Chapter 16 Electrical Specifications for component value requirements.

Figure 11-3. RC Oscillator External Connections

11.4 Oscillator Module Signals

The following paragraphs describe the signals that are inputs to and outputs from the oscillator module.

11.4.1 Crystal Amplifier Input Pin (OSC1)

The OSC1 pin is either an input to the crystal oscillator amplifier, an input to the RC oscillator circuit, or an external clock source.

For the internal oscillator configuration, the OSC1 pin can assume other functions according to Table 1-3. Function Priority in Shared Pins.

11.4.2 Crystal Amplifier Output Pin (OSC2/PTA4/BUSCLKX4)

For the XTAL oscillator device**,** the OSC2 pin is the crystal oscillator inverting amplifier output.

For the external clock option, the OSC2 pin is dedicated to the PTA4 I/O function. The OSC2EN bit has no effect.

For the internal oscillator or RC oscillator options, the OSC2 pin can assume other functions according to Table 1-3. Function Priority in Shared Pins, or the output of the oscillator clock (BUSCLKX4).

Table 11-1. OSC2 Pin Function

Option	OSC2 Pin Function
XTAL oscillator	Inverting OSC1
External clock	PTA4 I/O
Internal oscillator or RC oscillator	Controlled by OSC2EN bit in PTAPUE register OSC2EN = 0: PTA4 I/O OSC2EN = 1: BUSCLKX4 output

11.4.3 Oscillator Enable Signal (SIMOSCEN)

The SIMOSCEN signal comes from the system integration module (SIM) and enables/disables either the XTAL oscillator circuit, the RC oscillator, or the internal oscillator.

11.4.4 XTAL Oscillator Clock (XTALCLK)

XTALCLK is the XTAL oscillator output signal. It runs at the full speed of the crystal (f_{XCLK}) and comes directly from the crystal oscillator circuit. Figure 11-2 shows only the logical relation of XTALCLK to OSC1 and OSC2 and may not represent the actual circuitry. The duty cycle of XTALCLK is unknown and may depend on the crystal and other external factors. Also, the frequency and amplitude of XTALCLK can be unstable at start up.

11.4.5 RC Oscillator Clock (RCCLK)

RCCLK is the RC oscillator output signal. Its frequency is directly proportional to the time constant of external R and internal C. Figure 11-3 shows only the logical relation of RCCLK to OSC1 and may not represent the actual circuitry.

11.4.6 Internal Oscillator Clock (INTCLK)

INTCLK is the internal oscillator output signal. Its nominal frequency is fixed to 12.8 MHz, but it can be also trimmed using the oscillator trimming feature of the OSCTRIM register (see 11.3.1.1 Internal Oscillator Trimming).

11.4.7 Oscillator Out 2 (BUSCLKX4)

BUSCLKX4 is the same as the input clock (XTALCLK, RCCLK, or INTCLK). This signal is driven to the SIM module and is used to determine the COP cycles.

11.4.8 Oscillator Out (BUSCLKX2)

The frequency of this signal is equal to half of the BUSCLKX4, this signal is driven to the SIM for generation of the bus clocks used by the CPU and other modules on the MCU. BUSCLKX2 will be divided

11.8.1 Oscillator Status Register

The oscillator status register (OSCSTAT) contains the bits for switching from internal to external clock sources.

Address: $0036

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	R	R	R	R	R	R	ECGON	ECGST
Write:								
Reset:	0	0	0	0	0	0	0	0

R = Reserved; (shaded) = Unimplemented

Figure 11-4. Oscillator Status Register (OSCSTAT)

ECGON — External Clock Generator On Bit

This read/write bit enables external clock generator, so that the switching process can be initiated. This bit is forced low during reset. This bit is ignored in monitor mode with the internal oscillator bypassed, PTM or CTM mode.

1 = External clock generator enabled
0 = External clock generator disabled

ECGST — External Clock Status Bit

This read-only bit indicates whether or not an external clock source is engaged to drive the system clock.

1 = An external clock source engaged
0 = An external clock source disengaged

11.8.2 Oscillator Trim Register (OSCTRIM)

Address: $0038

	Bit 7	6	5	4	3	2	1	Bit 0
Read: Write:	TRIM7	TRIM6	TRIM5	TRIM4	TRIM3	TRIM2	TRIM1	TRIM0
Reset:	1	0	0	0	0	0	0	0

Figure 11-5. Oscillator Trim Register (OSCTRIM)

TRIM7–TRIM0 — Internal Oscillator Trim Factor Bits

These read/write bits change the size of the internal capacitor used by the internal oscillator. By measuring the period of the internal clock and adjusting this factor accordingly, the frequency of the internal clock can be fine tuned. Increasing (decreasing) this factor by one increases (decreases) the period by approximately 0.2% of the untrimmed period (the period for TRIM = $80). The trimmed frequency is guaranteed not to vary by more than ±5% over the full specified range of temperature and voltage. The reset value is $80, which sets the frequency to 12.8 MHz (3.2 MHz bus speed) ±25%.

Applications using the internal oscillator should copy the internal oscillator trim value at location $FFC0 or $FFC1 into this register to trim the clock source.

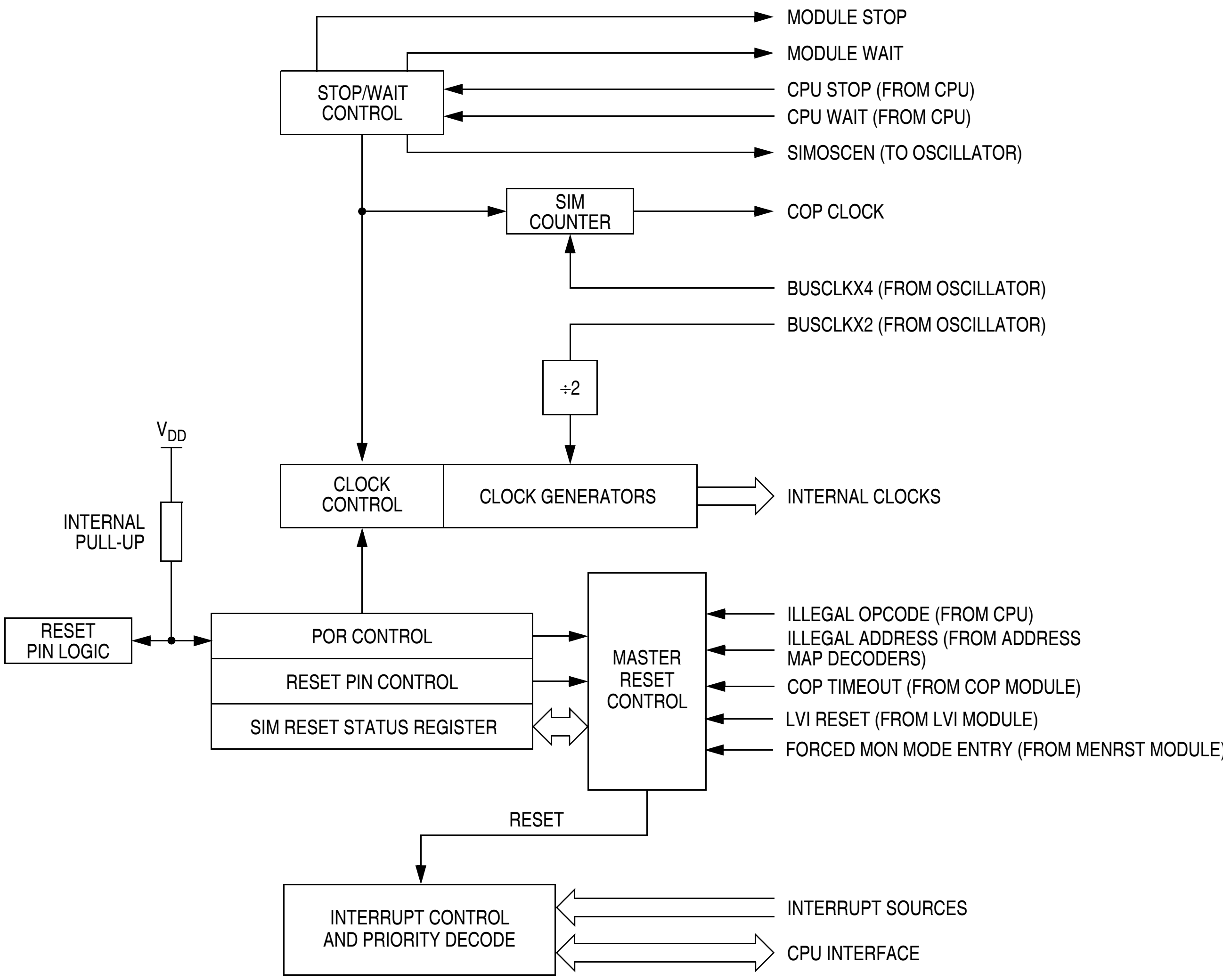


Figure 13-1. SIM Block Diagram

13.2 RST and IRQ Pins Initialization

RST and IRQ pins come out of reset as PTA3 and PTA2 respectively. RST and IRQ functions can be activated by programing CONFIG2 accordingly. Refer to Chapter 5 Configuration Register (CONFIG).

13.3 SIM Bus Clock Control and Generation

The bus clock generator provides system clock signals for the CPU and peripherals on the MCU. The system clocks are generated from an incoming clock, BUSCLKX2, as shown in Figure 13-2.

Chapter 14
Timer Interface Module (TIM)

14.1 Introduction

This section describes the timer interface module (TIM). The TIM is a two-channel timer that provides a timing reference with input capture, output compare, and pulse-width-modulation functions. Figure 14-2 is a block diagram of the TIM.

14.2 Features

Features of the TIM include the following:

- Two input capture/output compare channels
  - Rising-edge, falling-edge, or any-edge input capture trigger
  - Set, clear, or toggle output compare action
- Buffered and unbuffered pulse width modulation (PWM) signal generation
- Programmable TIM clock input
  - 7-frequency internal bus clock prescaler selection
  - External TIM clock input
- Free-running or modulo up-count operation
- Toggle any channel pin on overflow
- TIM counter stop and reset bits

14.3 Pin Name Conventions

The TIM shares two input/output (I/O) pins with two port A I/O pins. The full names of the TIM I/O pins are listed in Table 14-1. The generic pin name appear in the text that follows.

Table 14-1. Pin Name Conventions

TIM Generic Pin Names:	TCH0	TCH1	TCLK
Full TIM Pin Names:	PTA0/TCH0	PTA1/TCH1	PTA2/TCLK

15.3.1 Functional Description

Figure 15-9 shows a simplified diagram of monitor mode entry.

The monitor module receives and executes commands from a host computer. Figure 15-10, Figure 15-11, and Figure 15-12 show example circuits used to enter monitor mode and communicate with a host computer via a standard RS-232 interface.

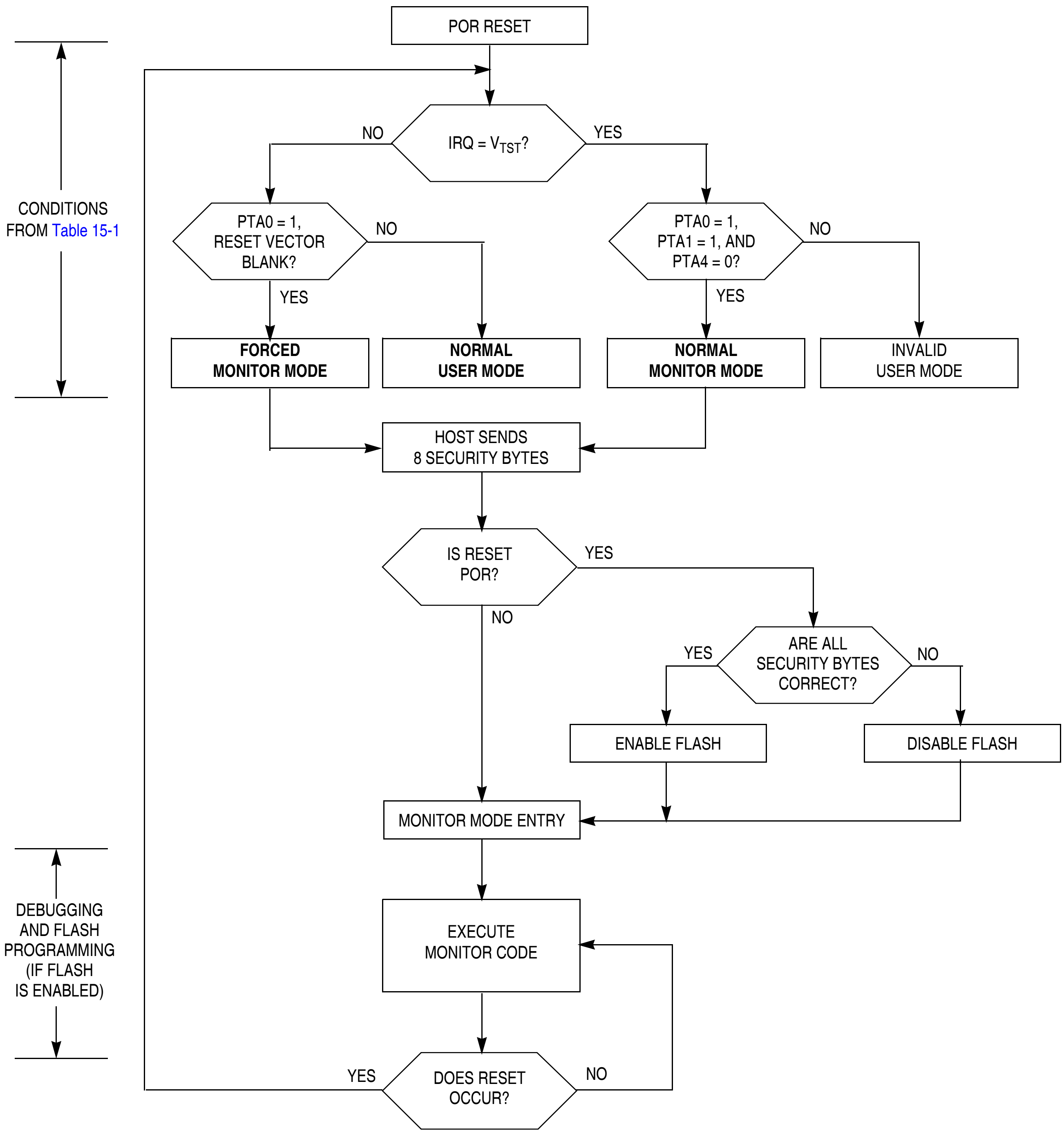
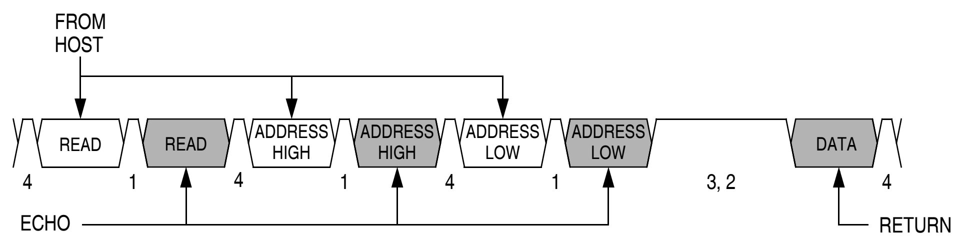


Figure 15-9. Simplified Monitor Mode Entry Flowchart

The monitor ROM firmware echoes each received byte back to the PTA0 pin for error checking. An 11-bit delay at the end of each command allows the host to send a break character to cancel the command. A delay of two bit times occurs before each echo and before READ, IREAD, or READSP data is returned. The data returned by a read command appears after the echo of the last byte of the command.

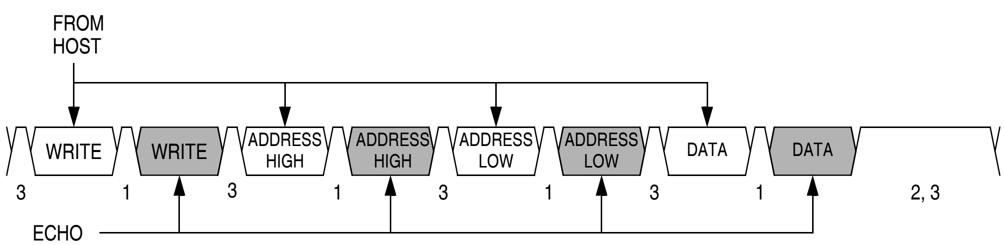
NOTE

Wait one bit time after each echo before sending the next byte.



Notes:
1 = Echo delay, 2 bit times
2 = Data return delay, 2 bit times
3 = Cancel command delay, 11 bit times
4 = Wait 1 bit time before sending next byte.

Figure 15-15. Read Transaction



Notes:
1 = Echo delay, 2 bit times
2 = Cancel command delay, 11 bit times
3 = Wait 1 bit time before sending next byte.

Figure 15-16. Write Transaction

A brief description of each monitor mode command is given in Table 15-3 through Table 15-8.

Table 15-3. READ (Read Memory) Command

Description	Read byte from memory
Operand	2-byte address in high-byte:low-byte order
Data Returned	Returns contents of specified address
Opcode	$4A

Command Sequence

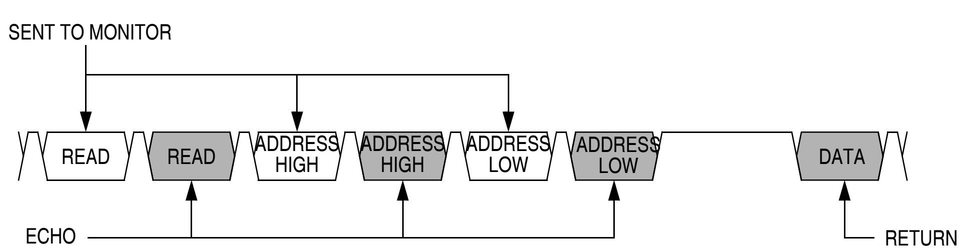


Table 15-4. WRITE (Write Memory) Command

Description	Write byte to memory
Operand	2-byte address in high-byte:low-byte order; low byte followed by data byte
Data Returned	None
Opcode	$49

Command Sequence

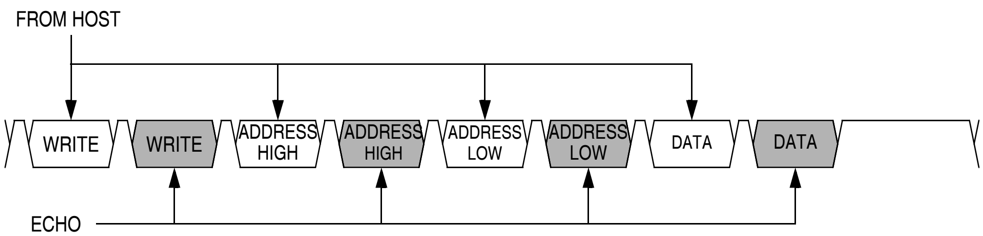


Table 15-5. IREAD (Indexed Read) Command

Description	Read next 2 bytes in memory from last address accessed
Operand	None
Data Returned	Returns contents of next two addresses
Opcode	$1A

Command Sequence

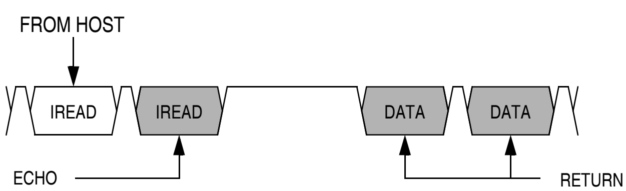
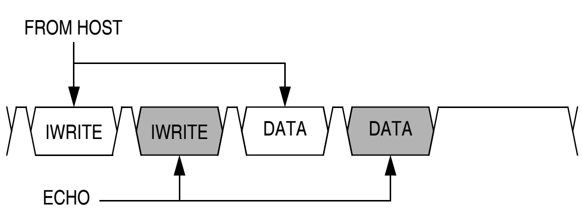


Table 15-6. IWRITE (Indexed Write) Command

Description	Write to last address accessed + 1
Operand	Single data byte
Data Returned	None
Opcode	$19

Command Sequence



A sequence of IREAD or IWRITE commands can access a block of memory sequentially over the full 64-Kbyte memory map.

16.7 5-V Control Timing

Characteristic[1]	Symbol	Min	Max	Unit
Internal operating frequency	f_{OP} (f_{Bus})	—	8	MHz
Internal clock period (1/f_{OP})	t_{cyc}	125	—	ns
$\overline{\text{RST}}$ input pulse width low	t_{RL}	100	—	ns
$\overline{\text{IRQ}}$ interrupt pulse width low (edge-triggered)	t_{ILIH}	100	—	ns
$\overline{\text{IRQ}}$ interrupt pulse period	t_{ILIL}	Note[2]	—	t_{cyc}

1. V_{DD} = 4.5 to 5.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H; timing shown with respect to 20% V_{DD} and 70% V_{SS}, unless otherwise noted.
2. The minimum period is the number of cycles it takes to execute the interrupt service routine plus 1 t_{cyc}.

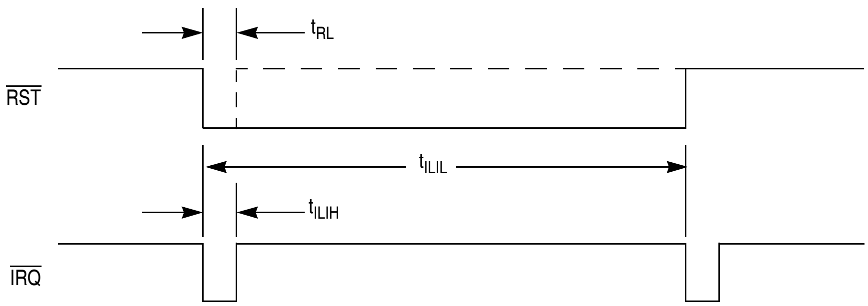


Figure 16-3. $\overline{\text{RST}}$ and $\overline{\text{IRQ}}$ Timing

16.10 Typical 3.0-V Output Drive Characteristics

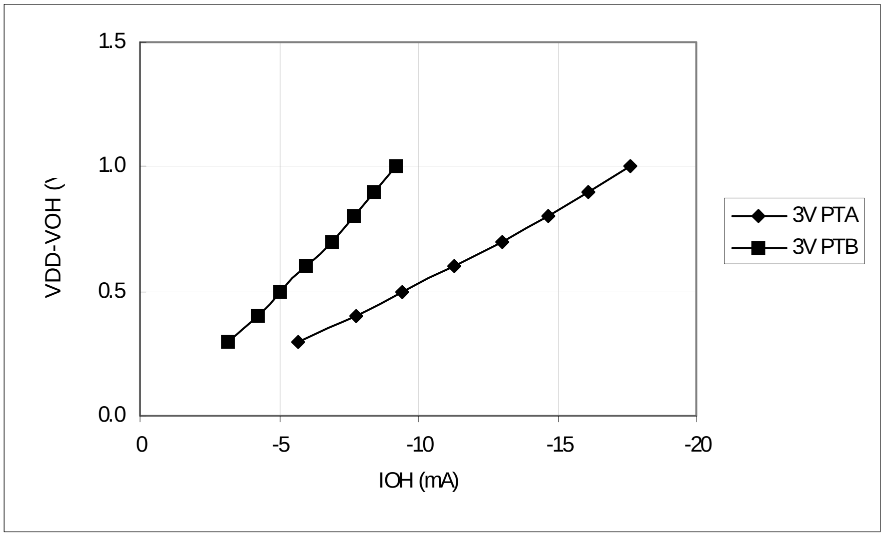


Figure 16-5. Typical 3-Volt Output High Voltage versus Output High Current (25•C)

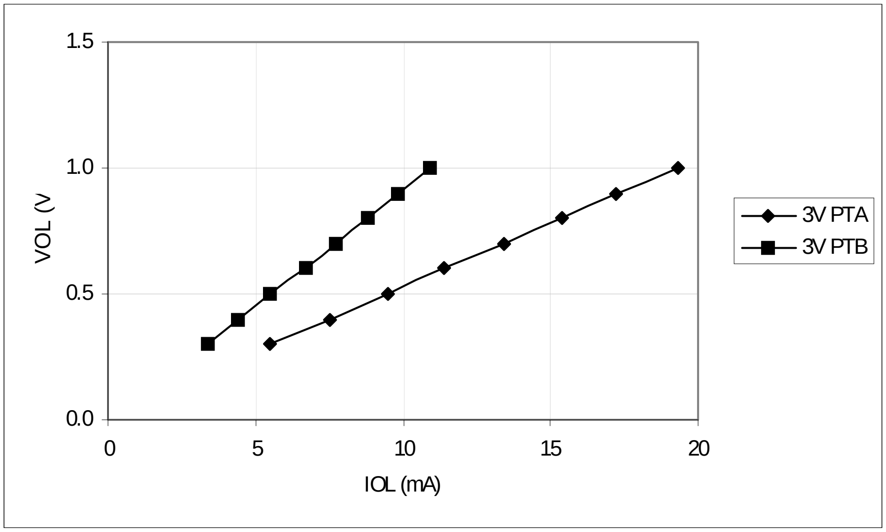


Figure 16-6. Typical 3-Volt Output Low Voltage versus Output Low Current (25•C)